Micropower Voltage Reference Diodes

LM285, LM385B

The LM285/LM385 series are micropower two-terminal bandgap voltage regulator diodes. Designed to operate over a wide current range of 10 μA to 20 mA, these devices feature exceptionally low dynamic impedance, low noise and stable operation over time and temperature. Tight voltage tolerances are achieved by on-chip trimming. The large dynamic operating range enables these devices to be used in applications with widely varying supplies with excellent regulation. Extremely low operating current make these devices ideal for micropower circuitry like portable instrumentation, regulators and other analog circuitry where extended battery life is required.

The LM285/LM385 series are packaged in a low cost TO-226 plastic case and are available in two voltage versions of 1.235 V and 2.500 V as denoted by the device suffix (see Ordering Information table). The LM285 is specified over a −40 °C to +85 °C temperature range while the LM385 is rated from 0 °C to +70 °C.

The LM385 is also available in a surface mount plastic package in voltages of 1.235 V and 2.500 V.

Features

- Operating Current from 10 μA to 20 mA
- 1.0%, 1.5%, 2.0% and 3.0% Initial Tolerance Grades
- Low Temperature Coefficient
- 1.0 Ω Dynamic Impedance
- Surface Mount Package Available
- These Devices are Pb-Free and are RoHS Compliant

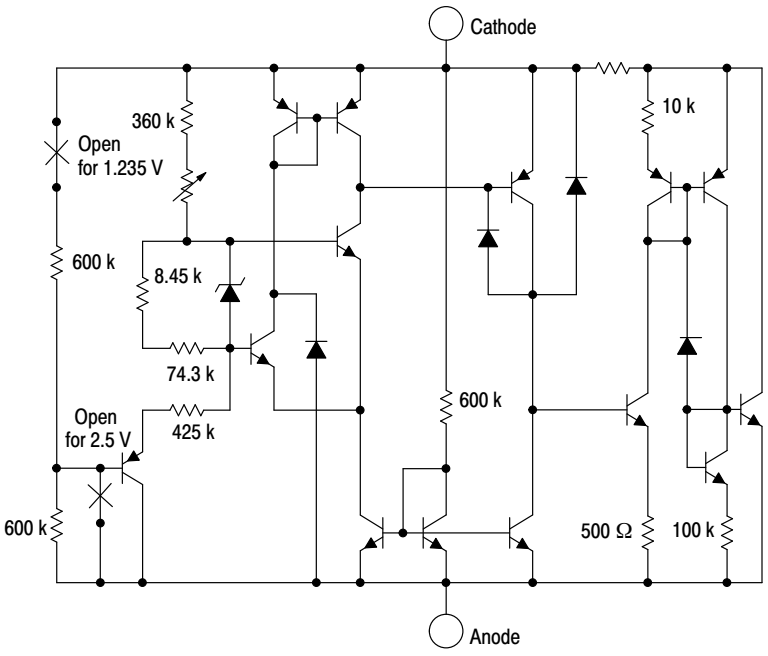
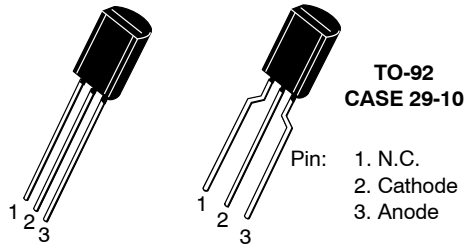


Figure 1. Representative Schematic Diagram

MARKING DIAGRAMS



SOIC-8
D SUFFIX
CASE 751

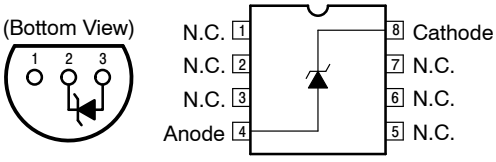


TO-92
CASE 29-10

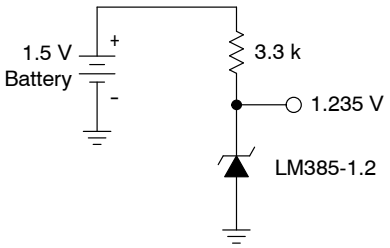
STRAIGHT LEAD BENT LEAD

xxx	= 1.2 or 2.5
y	= 2 or 3
z	= 1 or 2
A	= Assembly Location
L	= Wafer Lot
Y	= Year
W	= Work Week
▪	= Pb-Free Package

(Note: Microdot may be in either location)



Standard Application



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

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MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

Rating	Symbol	Value	Unit
Reverse Current	I_R	30	mA
Forward Current	I_F	10	mA
Operating Ambient Temperature Range LM285 LM385	T_A	 −40 to +85 0 to +70	°C
Operating Junction Temperature	T_J	+150	°C
Storage Temperature Range	T_{stg}	−65 to + 150	°C
Electrostatic Discharge Sensitivity (ESD) Human Body Model (HBM) Machine Model (MM) Charged Device Model (CDM)	ESD	 4000 400 2000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

Characteristic	Symbol	LM285-1.2			LM385-1.2/LM385B-1.2			Unit
		Min	Typ	Max	Min	Typ	Max	
Reverse Breakdown Voltage ($I_{Rmin} \le I_R \le 20$ mA)	$V_{(BR)R}$							V
LM285-1.2/LM385B-1.2		1.223	1.235	1.247	1.223	1.235	1.247	
$T_A = T_{low}$ to T_{high} (Note 1)		1.200	–	1.270	1.210	–	1.260	
LM385-1.2		–	–	–	1.205	1.235	1.260	
$T_A = T_{low}$ to T_{high} (Note 1)		–	–	–	1.192	–	1.273	
Minimum Operating Current	I_{Rmin}							μA
T_A = 25 °C		–	8.0	10		8.0	15	
$T_A = T_{low}$ to T_{high} (Note 1)		–	–	20	–	–	20	
Reverse Breakdown Voltage Change with Current	$\Delta V_{(BR)R}$							mV
$I_{Rmin} \le I_R \le 1.0$ mA, T_A = +25 °C		–	–	1.0	–	–	1.0	
$T_A = T_{low}$ to T_{high} (Note 1)		–	–	1.5	–	–	1.5	
1.0 mA ≤ $I_R \le 20$ mA, T_A = +25 °C		–	–	10	–	–	20	
$T_A = T_{low}$ to T_{high} (Note 1)		–	–	20	–	–	25	
Reverse Dynamic Impedance	Z							Ω
I_R = 100 μA, T_A = +25 °C		–	0.6	–	–	0.6	–	
Average Temperature Coefficient	$\Delta V_{(BR)}/\Delta T$							ppm/°C
10 μA ≤ $I_R \le 20$ mA, $T_A = T_{low}$ to T_{high} (Note 1)		–	80	–	–	80	–	
Wideband Noise (RMS)	n							μV
I_R = 100 μA, 10 Hz ≤ f ≤ 10 kHz		–	60	–	–	60	–	
Long Term Stability	S							ppm/kHR
I_R = 100 μA, T_A = +25 °C ± 0.1 °C		–	20	–	–	20	–	
Reverse Breakdown Voltage ($I_{Rmin} \le I_R \le 20$ mA)	$V_{(BR)R}$							V
LM285-2.5/LM385B-2.5		2.462	2.5	2.538	2.462	2.5	2.538	
$T_A = T_{low}$ to T_{high} (Note 1)		2.415	–	2.585	2.436	–	2.564	
LM385-2.5		–	–	–	2.425	2.5	2.575	
$T_A = T_{low}$ to T_{high} (Note 1)		–	–	–	2.400	–	2.600	
Minimum Operating Current	I_{Rmin}							μA
T_A = 25 °C		–	13	20	–	13	20	
$T_A = T_{low}$ to T_{high} (Note 1)		–	–	30	–	–	30	

1. T_{low} = −40 °C for LM285-1.2, LM285-2.5
   T_{high} = +85 °C for LM285-1.2, LM285-2.5
   T_{low} = 0 °C for LM385-1.2, LM385B-1.2, LM385-2.5, LM385B-2.5
   T_{high} = +70 °C for LM385-1.2, LM385B-1.2, LM385-2.5, LM385B-2.5

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ELECTRICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

Characteristic	Symbol	LM285-1.2			LM385-1.2/LM385B-1.2			Unit
		Min	Typ	Max	Min	Typ	Max	
Reverse Breakdown Voltage Change with Current	$\Delta V_{(BR)R}$							mV
$I_{Rmin} \le I_R \le 1.0$ mA, T_A = +25 °C		–	–	1.0	–	–	2.0	
$T_A = T_{low}$ to T_{high} (Note 2)		–	–	1.5	–	–	2.5	
1.0 mA ≤ $I_R \le 20$ mA, T_A = +25 °C		–	–	10	–	–	20	
$T_A = T_{low}$ to T_{high} (Note 2)		–	–	20	–	–	25	
Reverse Dynamic Impedance	Z							Ω
I_R = 100 μA, T_A = +25 °C		–	0.6	–	–	0.6	–	
Average Temperature Coefficient	$\Delta V_{(BR)}/\Delta T$							ppm/°C
20 μA ≤ $I_R \le 20$ mA, $T_A = T_{low}$ to T_{high} (Note 2)		–	80	–	–	80	–	
Wideband Noise (RMS)	n							μV
I_R = 100 μA, 10 Hz ≤ f ≤ 10 kHz		–	120	–	–	120	–	
Long Term Stability	S							ppm/kHR
I_R = 100 μA, T_A = +25 °C ± 0.1 °C		–	20	–	–	20	–	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. T_{low} = −40 °C for LM285-1.2, LM285-2.5
   T_{high} = +85 °C for LM285-1.2, LM285-2.5
   T_{low} = 0 °C for LM385-1.2, LM385B-1.2, LM385-2.5, LM385B-2.5
   T_{high} = +70 °C for LM385-1.2, LM385B-1.2, LM385-2.5, LM385B-2.5

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TYPICAL PERFORMANCE CURVES FOR LM285−1.2/385−1.2/385B−1.2

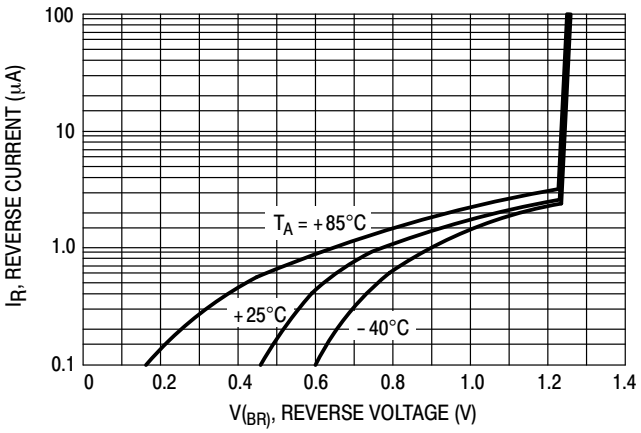

Figure 2. Reverse Characteristics

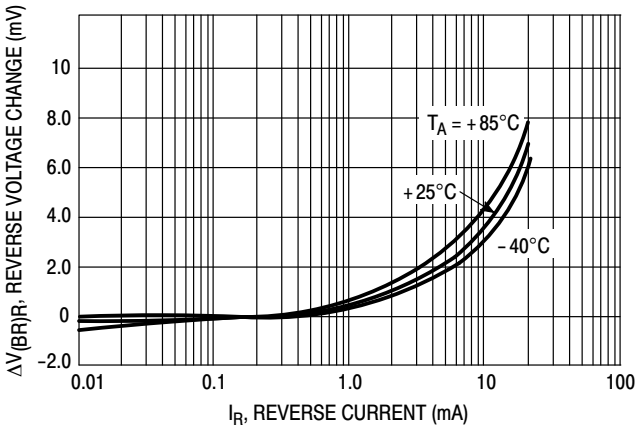

Figure 3. Reverse Characteristics

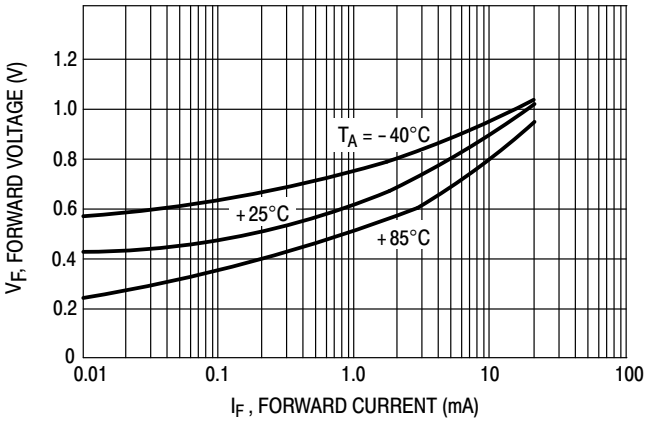

Figure 4. Forward Characteristics

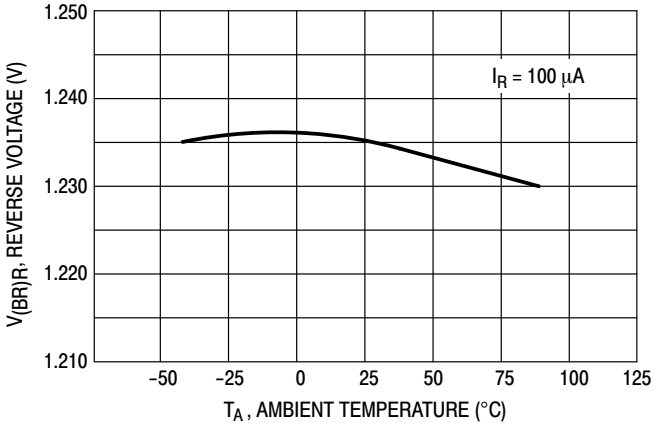

Figure 5. Temperature Drift

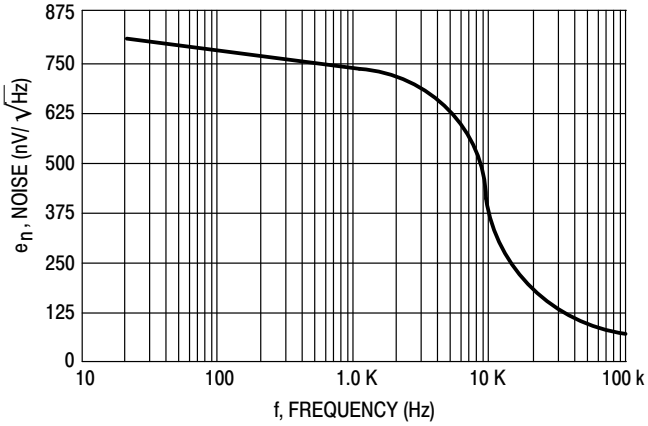

Figure 6. Noise Voltage

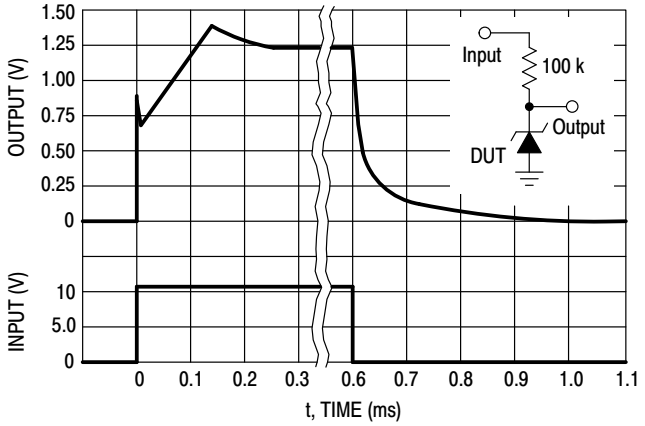

Figure 7. Response Time

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TYPICAL PERFORMANCE CURVES FOR LM285−2.5/385−2.5/385B−2.5

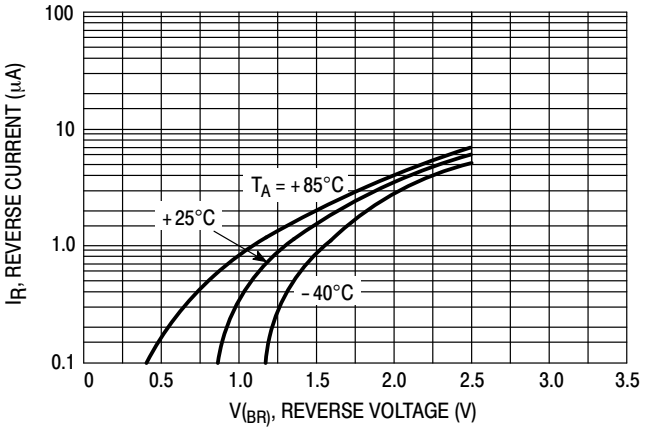

Figure 8. Reverse Characteristics

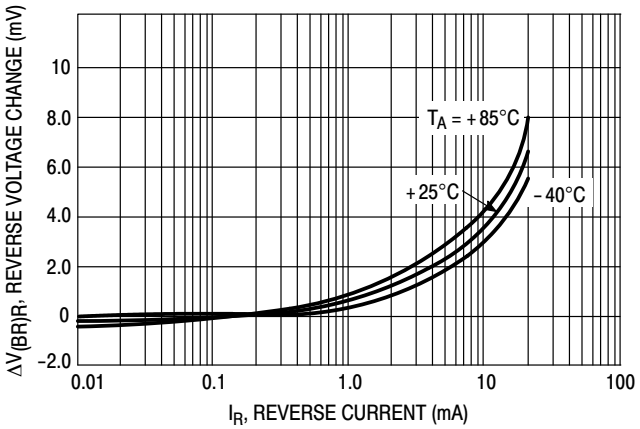

Figure 9. Reverse Characteristics

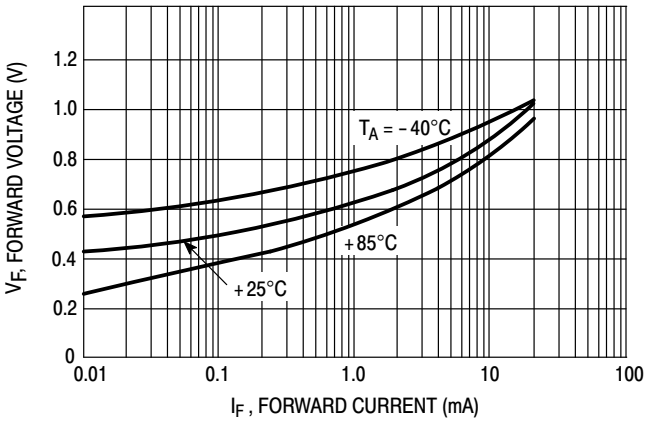

Figure 10. Forward Characteristics

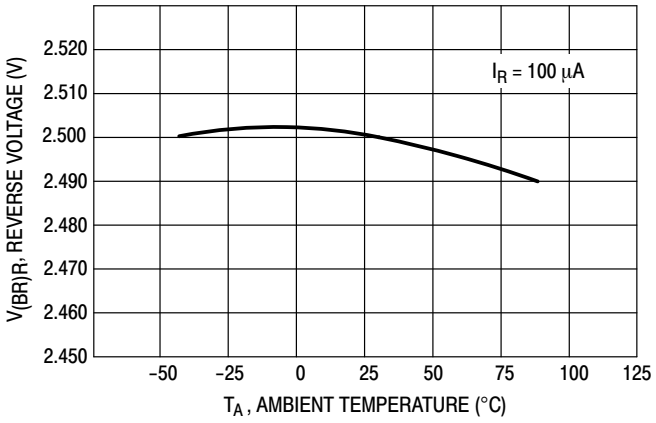

Figure 11. Temperature Drift

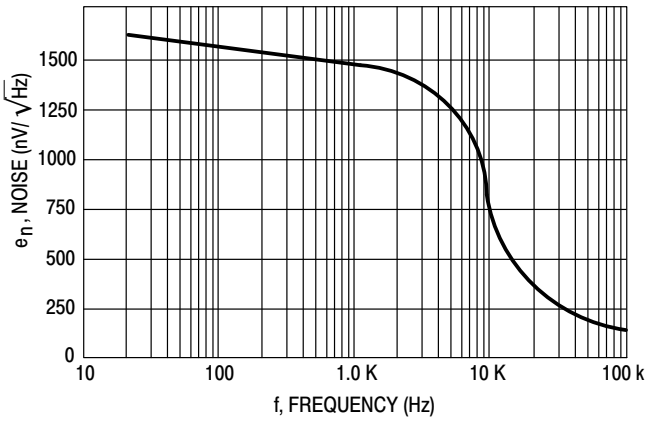

Figure 12. Noise Voltage

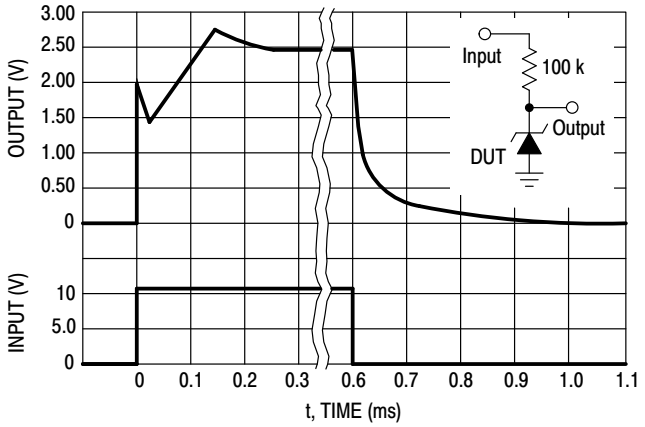

Figure 13. Response Time

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ORDERING INFORMATION

Device	Operating Temperature Range	Reverse Break-Down Voltage	Package	Shipping†
LM285D-1.2G	T_A = −40 °C to +85 °C	1.235 V	SOIC-8 (Pb-Free)	98 Units / Rail
LM285D-1.2R2G			SOIC-8 (Pb-Free)	2500 / Tape & Reel
LM285D-2.5G		2.500 V	SOIC-8 (Pb-Free)	98 Units / Rail
LM285D-2.5R2G			SOIC-8 (Pb-Free)	2500 / Tape & Reel
LM385BD-1.2R2G	T_A = 0 °C to +70 °C	1.235 V	SOIC-8 (Pb-Free)	2500 / Tape & Reel
LM385BD-2.5G		2.500 V	SOIC-8 (Pb-Free)	98 Units / Rail
LM385BD-2.5R2G			SOIC-8 (Pb-Free)	2500 / Tape & Reel
LM385D-1.2G		1.235 V	SOIC-8 (Pb-Free)	98 Units / Rail
LM385D-1.2R2G			SOIC-8 (Pb-Free)	2500 / Tape & Reel
LM385D-2.5G		2.500 V	SOIC-8 (Pb-Free)	98 Units / Rail
LM385D-2.5R2G			SOIC-8 (Pb-Free)	2500 / Tape & Reel

DISCONTINUED (Note 3)

LM285D-1.2	T_A = −40 °C to +85 °C	1.235 V	SOIC-8	98 Units / Rail
LM285D-1.2R2			SOIC-8	2500 / Tape & Reel
LM285D-2.5		2.500 V	SOIC-8	98 Units / Rail
LM285D-2.5R2			SOIC-8	2500 / Tape & Reel
LM285Z-1.2		1.235 V	TO-92	2000 Units / Bag
LM285Z-1.2G			TO-92 (Pb-Free)	2000 Units / Bag
LM285Z-2.5		2.500 V	TO-92	2000 Units / Bag
LM285Z-1.2RA		1.235 V	TO-92	2000 / Tape & Reel
LM285Z-1.2RAG			TO-92 (Pb-Free)	2000 / Tape & Reel
LM285Z-2.5RA		2.500 V	TO-92	2000 / Tape & Reel
LM285Z-2.5RAG			TO-92 (Pb-Free)	2000 / Tape & Reel
LM285Z-2.5RP			TO-92	2000 Units / Fan-Fold
LM285Z-2.5RPG			TO-92 (Pb-Free)	2000 Units / Fan-Fold
LM285Z-2.5G		2.500 V	TO-92 (Pb-Free)	2000 Units / Bag

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ORDERING INFORMATION (continued)

Device	Operating Temperature Range	Reverse Break-Down Voltage	Package	Shipping†
DISCONTINUED (Note 3)				
LM385BD-1.2	T_A = 0 °C to +70 °C	1.235 V	SOIC-8	98 Units / Rail
LM385BD-1.2G			SOIC-8 (Pb-Free)	98 Units / Rail
LM385BD-1.2R2			SOIC-8	2500 / Tape & Reel
LM385BD-2.5		2.500 V	SOIC-8	98 Units / Rail
LM385BD-2.5R2			SOIC-8	2500 / Tape & Reel
LM385BZ-1.2		1.235 V	TO-92	2000 Units / Bag
LM385BZ-1.2G			TO-92 (Pb-Free)	2000 Units / Bag
LM385BZ-1.2RA			TO-92	2000 / Tape & Reel
LM385BZ-1.2RAG			TO-92 (Pb-Free)	2000 / Tape & Reel
LM385BZ-2.5		2.500 V	TO-92	2000 Units / Bag
LM385BZ-2.5G			TO-92 (Pb-Free)	2000 Units / Bag
LM385BZ-2.5RA			TO-92	2000 / Tape & Reel
LM385BZ-2.5RAG			TO-92 (Pb-Free)	2000 / Tape & Reel
LM385D-1.2		1.235 V	SOIC-8	98 Units / Rail
LM385D-1.2R2			SOIC-8	2500 / Tape & Reel
LM385D-2.5		2.500 V	SOIC-8	98 Units / Rail
LM385D-2.5R2			SOIC-8	2500 / Tape & Reel
LM385Z-1.2		1.235 V	TO-92	2000 Units / Bag
LM385Z-1.2G			TO-92 (Pb-Free)	2000 Units / Bag
LM385Z-1.2RA			TO-92	2000 / Tape & Reel
LM385Z-1.2RAG			TO-92 (Pb-Free)	2000 / Tape & Reel
LM385Z-1.2RP			TO-92	2000 / Ammo Box
LM385Z-1.2RPG			TO-92 (Pb-Free)	2000 / Ammo Box
LM385Z-2.5		2.500 V	TO-92	2000 Units / Bag
LM385Z-2.5RP			TO-92	2000 / Ammo Box
LM385Z-2.5RPG			TO-92 (Pb-Free)	2000 / Ammo Box
LM385Z-2.5G		2.500 V	TO-92 (Pb-Free)	2000 Units / Bag

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

3. **DISCONTINUED:** These devices are not available. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

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REVISION HISTORY

Revision	Description of Changes	Date
13	LM385Z-2.5G, LM285Z-2.5G OPNs Marked as Discontinued.	07/15/2025

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.

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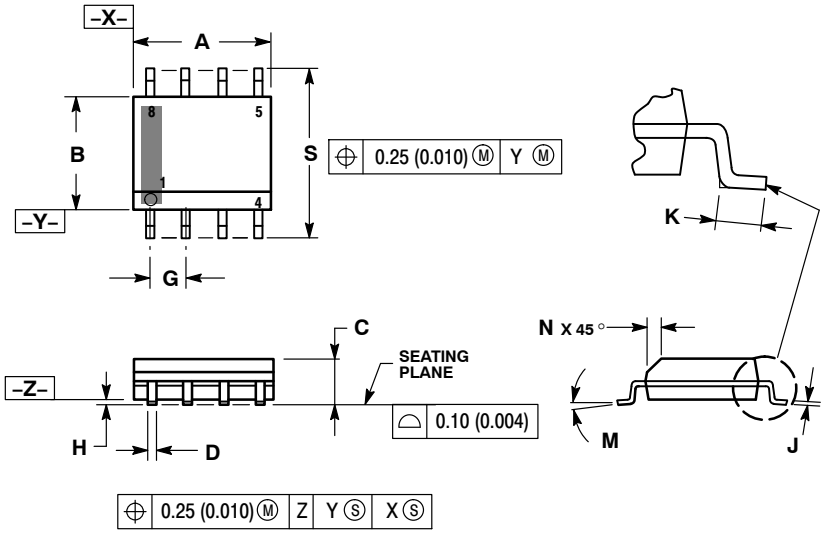
SCALE 1:1

SOIC−8 NB
CASE 751−07
ISSUE AK

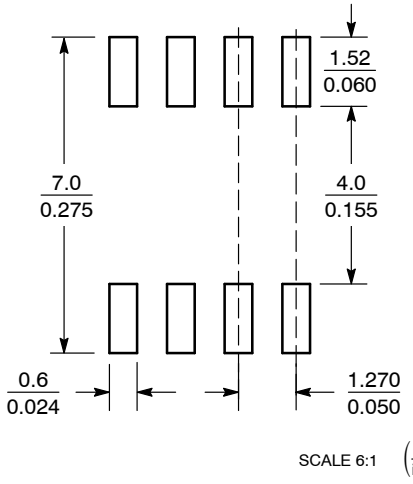
DATE 16 FEB 2011



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751−01 THRU 751−06 ARE OBSOLETE. NEW STANDARD IS 751−07.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

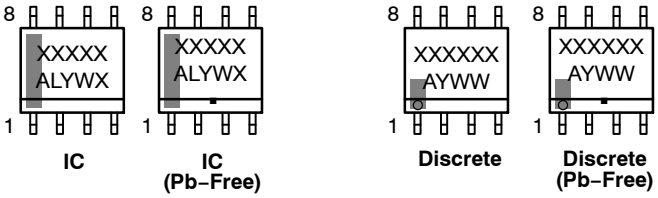
SOLDERING FOOTPRINT*



SCALE 6:1 (mm / inches)

*For additional information on our Pb−Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb−Free Package

XXXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

DOCUMENT NUMBER:	**98ASB42564B**	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	**SOIC−8 NB**		**PAGE 1 OF 2**

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SOIC−8 NB
CASE 751−07
ISSUE AK

DATE 16 FEB 2011

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. COLLECTOR
4. EMITTER
5. EMITTER
6. BASE
7. BASE
8. EMITTER

STYLE 2:
PIN 1. COLLECTOR, DIE, #1
2. COLLECTOR, #1
3. COLLECTOR, #2
4. COLLECTOR, #2
5. BASE, #2
6. EMITTER, #2
7. BASE, #1
8. EMITTER, #1

STYLE 3:
PIN 1. DRAIN, DIE #1
2. DRAIN, #1
3. DRAIN, #2
4. DRAIN, #2
5. GATE, #2
6. SOURCE, #2
7. GATE, #1
8. SOURCE, #1

STYLE 4:
PIN 1. ANODE
2. ANODE
3. ANODE
4. ANODE
5. ANODE
6. ANODE
7. ANODE
8. COMMON CATHODE

STYLE 5:
PIN 1. DRAIN
2. DRAIN
3. DRAIN
4. DRAIN
5. GATE
6. GATE
7. SOURCE
8. SOURCE

STYLE 6:
PIN 1. SOURCE
2. DRAIN
3. DRAIN
4. SOURCE
5. SOURCE
6. GATE
7. GATE
8. SOURCE

STYLE 7:
PIN 1. INPUT
2. EXTERNAL BYPASS
3. THIRD STAGE SOURCE
4. GROUND
5. DRAIN
6. GATE 3
7. SECOND STAGE Vd
8. FIRST STAGE Vd

STYLE 8:
PIN 1. COLLECTOR, DIE #1
2. BASE, #1
3. BASE, #2
4. COLLECTOR, #2
5. COLLECTOR, #2
6. EMITTER, #2
7. EMITTER, #1
8. COLLECTOR, #1

STYLE 9:
PIN 1. EMITTER, COMMON
2. COLLECTOR, DIE #1
3. COLLECTOR, DIE #2
4. EMITTER, COMMON
5. EMITTER, COMMON
6. BASE, DIE #2
7. BASE, DIE #1
8. EMITTER, COMMON

STYLE 10:
PIN 1. GROUND
2. BIAS 1
3. OUTPUT
4. GROUND
5. GROUND
6. BIAS 2
7. INPUT
8. GROUND

STYLE 11:
PIN 1. SOURCE 1
2. GATE 1
3. SOURCE 2
4. GATE 2
5. DRAIN 2
6. DRAIN 2
7. DRAIN 1
8. DRAIN 1

STYLE 12:
PIN 1. SOURCE
2. SOURCE
3. SOURCE
4. GATE
5. DRAIN
6. DRAIN
7. DRAIN
8. DRAIN

STYLE 13:
PIN 1. N.C.
2. SOURCE
3. SOURCE
4. GATE
5. DRAIN
6. DRAIN
7. DRAIN
8. DRAIN

STYLE 14:
PIN 1. N−SOURCE
2. N−GATE
3. P−SOURCE
4. P−GATE
5. P−DRAIN
6. P−DRAIN
7. N−DRAIN
8. N−DRAIN

STYLE 15:
PIN 1. ANODE 1
2. ANODE 1
3. ANODE 1
4. ANODE 1
5. CATHODE, COMMON
6. CATHODE, COMMON
7. CATHODE, COMMON
8. CATHODE, COMMON

STYLE 16:
PIN 1. EMITTER, DIE #1
2. BASE, DIE #1
3. EMITTER, DIE #2
4. BASE, DIE #2
5. COLLECTOR, DIE #2
6. COLLECTOR, DIE #2
7. COLLECTOR, DIE #1
8. COLLECTOR, DIE #1

STYLE 17:
PIN 1. VCC
2. V2OUT
3. V1OUT
4. TXE
5. RXE
6. VEE
7. GND
8. ACC

STYLE 18:
PIN 1. ANODE
2. ANODE
3. SOURCE
4. GATE
5. DRAIN
6. DRAIN
7. CATHODE
8. CATHODE

STYLE 19:
PIN 1. SOURCE 1
2. GATE 1
3. SOURCE 2
4. GATE 2
5. DRAIN 2
6. MIRROR 2
7. DRAIN 1
8. MIRROR 1

STYLE 20:
PIN 1. SOURCE (N)
2. GATE (N)
3. SOURCE (P)
4. GATE (P)
5. DRAIN
6. DRAIN
7. DRAIN
8. DRAIN

STYLE 21:
PIN 1. CATHODE 1
2. CATHODE 2
3. CATHODE 3
4. CATHODE 4
5. CATHODE 5
6. COMMON ANODE
7. COMMON ANODE
8. CATHODE 6

STYLE 22:
PIN 1. I/O LINE 1
2. COMMON CATHODE/VCC
3. COMMON CATHODE/VCC
4. I/O LINE 3
5. COMMON ANODE/GND
6. I/O LINE 4
7. I/O LINE 5
8. COMMON ANODE/GND

STYLE 23:
PIN 1. LINE 1 IN
2. COMMON ANODE/GND
3. COMMON ANODE/GND
4. LINE 2 IN
5. LINE 2 OUT
6. COMMON ANODE/GND
7. COMMON ANODE/GND
8. LINE 1 OUT

STYLE 24:
PIN 1. BASE
2. EMITTER
3. COLLECTOR/ANODE
4. COLLECTOR/ANODE
5. CATHODE
6. CATHODE
7. COLLECTOR/ANODE
8. COLLECTOR/ANODE

STYLE 25:
PIN 1. VIN
2. N/C
3. REXT
4. GND
5. IOUT
6. IOUT
7. IOUT
8. IOUT

STYLE 26:
PIN 1. GND
2. dv/dt
3. ENABLE
4. ILIMIT
5. SOURCE
6. SOURCE
7. SOURCE
8. VCC

STYLE 27:
PIN 1. ILIMIT
2. OVLO
3. UVLO
4. INPUT+
5. SOURCE
6. SOURCE
7. SOURCE
8. DRAIN

STYLE 28:
PIN 1. SW_TO_GND
2. DASIC_OFF
3. DASIC_SW_DET
4. GND
5. V_MON
6. VBULK
7. VBULK
8. VIN

STYLE 29:
PIN 1. BASE, DIE #1
2. EMITTER, #1
3. BASE, #2
4. EMITTER, #2
5. COLLECTOR, #2
6. COLLECTOR, #2
7. COLLECTOR, #1
8. COLLECTOR, #1

STYLE 30:
PIN 1. DRAIN 1
2. DRAIN 1
3. GATE 2
4. SOURCE 2
5. SOURCE 1/DRAIN 2
6. SOURCE 1/DRAIN 2
7. SOURCE 1/DRAIN 2
8. GATE 1

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